



#### 20V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> Tc = +25°C
20V	$4.6 \text{m}\Omega$ @ V <sub>GS</sub> = $4.5 \text{V}$	100A
200	$8.7 \text{m}\Omega$ @ V <sub>GS</sub> = $2.5 \text{V}$	80A

### **Description**

This new generation N-Channel Enhancement Mode MOSFET has been designed to minimize  $R_{DS(ON)}$  yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and Load switch.

### **Features**

- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

# **Applications**

- Motor Control
- DC-DC Converters
- Power Management

### **Mechanical Data**

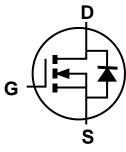
- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208(3)
- Terminal Connections: See Diagram Below
- Weight: 0.097 grams (Approximate)



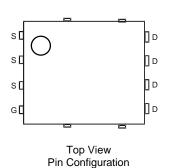




**Bottom View** 



Internal Schematic



## **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN2005UPS-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**



☐ ☐ Hanufacturer's Marking
N2005US = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 20 = 2020)
WW = Week Code (01 to 53)

# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	20	V		
Gate-Source Voltage			Vgss	±12	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	20 15	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	$T_C = +25$ °C $T_C = +70$ °C	l <sub>D</sub>	100 88	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	lом	150	Α		
Maximum Continuous Body Diode Forward Current	Is	150	Α		
Avalanche Current (Note 7) L=0.2mH	las	36	Α		
Avalanche Energy (Note 7) L=0.2mH			Eas	133	mJ

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	•	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	98	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	RθJA	83	
Total Power Dissipation (Note 6)		P <sub>D</sub>	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	р	51	°C/W
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{\theta JA}$	43	
Thermal Resistance, Junction to Case		Rejc	1.5	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

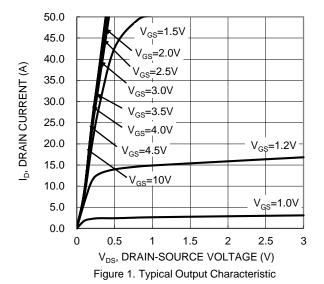


# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 12V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(TH)	0.4	0.7	1.2	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	_	4.6	mΩ	V <sub>G</sub> S = 4.5V, I <sub>D</sub> = 13.5A	
Static Drain-Source On-Resistance	Rds(on)	_	_	8.7	11122	Vgs = 2.5V, ID = 13.5A	
Diode Forward Voltage	VsD	_	0.8	1.1	V	Vgs = 0V, Is = 27A	
DYNAMIC CHARACTERISTICS (Note 9)	DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	-	5337	_	pF	1, 40,4,4, 0,4	
Output Capacitance	Coss	_	560	_	pF	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	505	_	pF	1 – 1101112	
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	60	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	142	_	nC	V 40V L 07A	
Gate-Source Charge	Q <sub>gs</sub>	_	7	_	nC	V <sub>DS</sub> = 16V, I <sub>D</sub> = 27A	
Gate-Drain Charge	Q <sub>gd</sub>	_	11	_	nC	]	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	12.4	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	29.8	_	ns	$V_{GS} = 5V, V_{DS} = 10V,$	
Turn-Off Delay Time	tD(OFF)	_	117	_	ns	$R_G = 4.7\Omega$ , $I_D = 13.5A$	
Turn-Off Fall Time	tF	_	52	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	17.8	_	ns	I <sub>F</sub> = 13.5A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	QRR	_	8.6	_	nC	I <sub>F</sub> = 13.5A, di/dt = 100A/μs	

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:





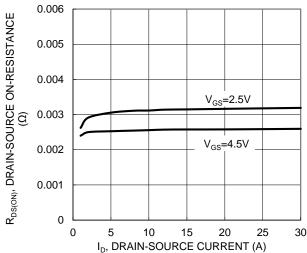


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

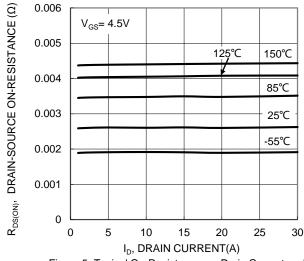
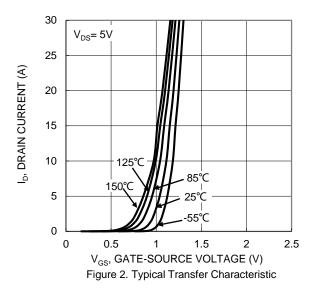
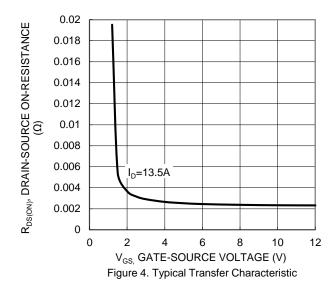


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





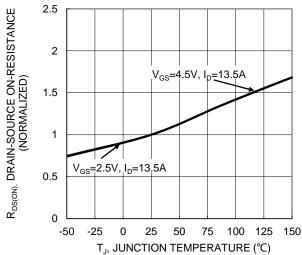


Figure 6. On-Resistance Variation with Junction Temperature





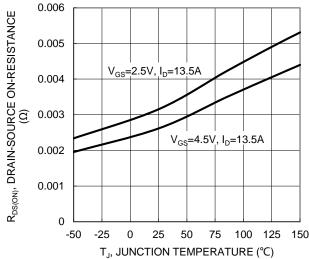
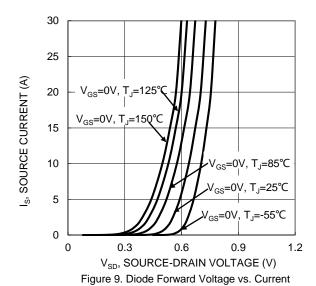


Figure 7. On-Resistance Variation with Junction Temperature



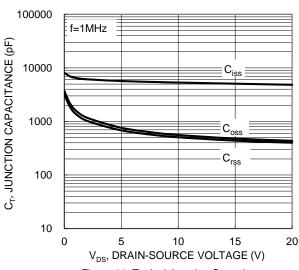


Figure 11. Typical Junction Capacitance

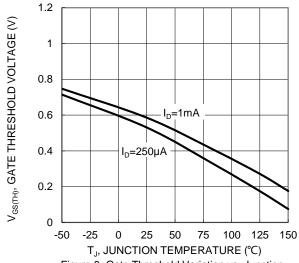


Figure 8. Gate Threshold Variation vs. Junction Temperature

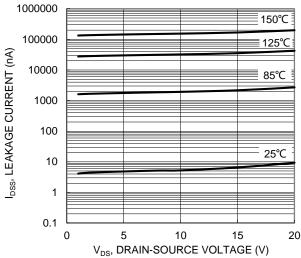


Figure 10 .Typical Drain-Source Leakage Current vs. Voltage

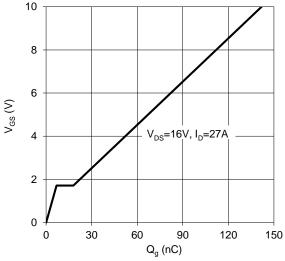


Figure 12. Gate Charge



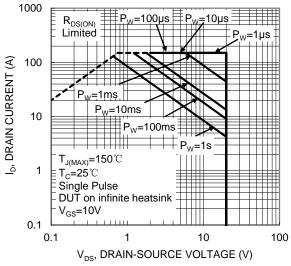


Figure 13. SOA, Safe Operation Area

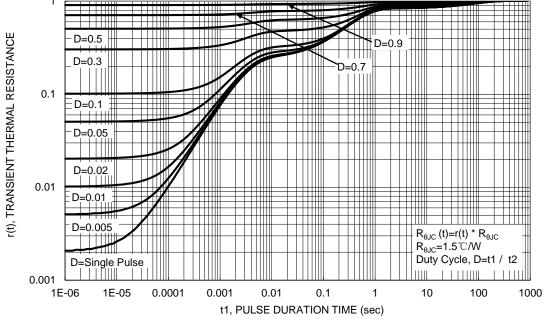


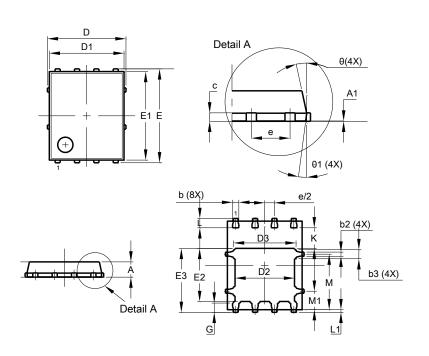
Figure 14. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8

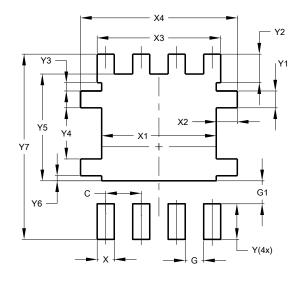


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	;	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(	6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8



C       1.270         G       0.660         G1       0.820         X       0.610         X1       4.100         X2       0.755         X3       4.420         X4       5.610         Y       1.270         Y1       0.600         Y2       1.020         Y3       0.295         Y4       1.825         Y5       3.810         Y6       0.180         Y7       6.610	Dimensions	Value (in mm)			
G1     0.820       X     0.610       X1     4.100       X2     0.755       X3     4.420       X4     5.610       Y     1.270       Y1     0.600       Y2     1.020       Y3     0.295       Y4     1.825       Y5     3.810       Y6     0.180	С	1.270			
X 0.610 X1 4.100 X2 0.755 X3 4.420 X4 5.610 Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	G	0.660			
X1 4.100 X2 0.755 X3 4.420 X4 5.610 Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	G1	0.820			
X2 0.755 X3 4.420 X4 5.610 Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	X	0.610			
X3 4.420 X4 5.610 Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	X1	4.100			
X4 5.610 Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	X2	0.755			
Y 1.270 Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	Х3	4.420			
Y1 0.600 Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	X4	5.610			
Y2 1.020 Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	Y	1.270			
Y3 0.295 Y4 1.825 Y5 3.810 Y6 0.180	Y1	0.600			
Y4 1.825 Y5 3.810 Y6 0.180	Y2	1.020			
Y5 3.810 Y6 0.180	Y3	0.295			
<b>Y6</b> 0.180	Y4	1.825			
	Y5	3.810			
<b>Y7</b> 6.610	Y6	0.180			
	Y7	6.610			



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